Dotted box > PCB manufacturer info

	Layer Name	Туре	Material	Thickness (mils)	Color	Epsilon R	Loss Tangent
А	F.Silkscreen	Top Silk Screen	Not specified	0 mils	Not specified	1	0
	F.Paste	Top Solder Paste		0 mils		1	0
	F.Mask	Top Solder Mask	Not specified	0.3937 mils	Not specified	3.3	0
	F.Cu	copper		1.37795 mils		1	0
	Dielectric	core	FR4	59.44882 mils	Not specified	4.5	0.02
	B.Cu	copper		1.37795 mils		1	0
	B.Mask	Bottom Solder Mask	Not specified	0.3937 mils	Not specified	3.3	0
	B.Paste	Bottom Solder Paste		0 mils		1	0
	B.Silkscreen	Bottom Silk Screen	Not specified	0 mils	Not specified	1	0

BOARD CHARACTERISTICS

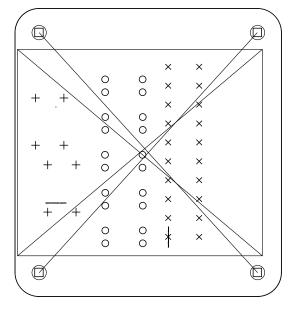
Copper Layer Count: 2 Board Thickness: 1.6000 mm

Board overall dimensions: 70.4850 mm x 76.2000 mm

Min track/spacing: 0.0000 mm / 0.0000 mm Min hole diameter: 0.3000 mm Copper Finish: None Impedance Control: No

Plated Board Edge: No Castellated pads:

Edge card connectors:



Drill Map:

× 1.397mm / 0.0550" (20 holes) ○ 1.800mm / 0.0709" (20 holes) + 2.108mm / 0.0830" (8 holes) □ 3.175mm / 0.1250" (4 holes) (not plated)

NOTES

LAYERS

1.Layers: 2 2.Thickness: 1.6 3.Surface finish: HASL 4.Outer Copper Weight: 2oz 5 Via covering: Tented 6.Min hole size: .3mm 7.Gold Fingers: No 8.Castellated Holes: No

9.Edge Plating: No

User.1

Edge.Cuts

Spartan Robotics

File: PowerDistribution.kicad_pcb

Title: Power Distribution Board

Size: B Date: 2024-10-12 KiCad E.D.A. 8.0.2-1 Rev: R2 Page: 1/1